ON FOR PATENT APPLY

ATTORALY'S DOCKET NO.: TESSERA 3.0-085

As a below-named inventor. I hereby declare that: My residence, post office address and citizenship are as stated below next to my name; I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: METHODS FOR MANUFACTURING A SEMICONDUCTOR PACKAGE, the specification of which is attached hereto was filed on April 18, 1996 as United States Application Number 08/634,464 and was amended on __ (if applicable). I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is meterial to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56. I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed: PRIOR FOREIGN APPLICATION(S) DATE OF FILING COUNTRY APPLICATION NUMBER (day, month, year) PRIORITY CLAIMED YES 🗌 NO [YES 🗌 NO 🗆 YES 🗌 NO 🗆 LISTING OF FOREIGN APPLICATIONS CONTINUED ON PAGE 2 HEREOF ☐ YES ☒ NO I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below: Application Number: Filing Date: I Application Number: Filing Date: T I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject Filing Date: Status (patented, pending, abandoned):

matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

Application Serial Number:

Application Serial Number:

Filing Date:

Status (patented, pending, abandoned):

LISTING OF US APPLICATIONS CONTINUED ON PAGE 2 HEREOF: YES NO

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith.

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